



3.3V, Wide Bandwidth Quad 2:1 Mux/Demux LanSwitch

Features

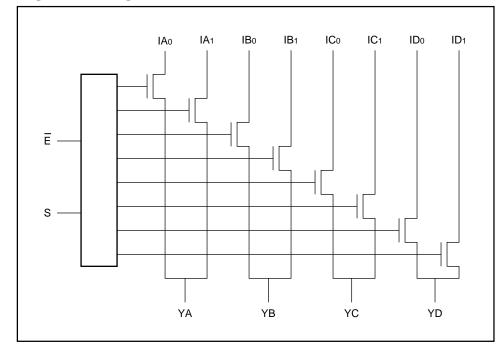
- Replaces mechanical relays
- High-performance, low-cost solution for switching between different LAN signals
- Ultra-low quiescent power (0.1µA typical)
- Low crosstalk: -90dB @ 30 MHz
- Low insertion loss or on-resistance: 3Ω typical
- Single supply operation: 3.3V
- Off isolation: -45dB @ 30 MHz
- Wide bandwidth data rates > 200 MHz
- Packages available:
 - 16-pin 150 mil wide plastic QSOP (Q)
 - 16-pin 173 mil wide plastic TSSOP (L)

Description

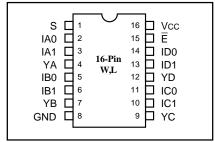
Pericom Semiconductor's PI3L series of logic circuits are produced using the Company's advanced submicron CMOS technology.

The PI3L100 is a Quad 2:1 multiplexer/demultiplexer LanSwitch with three-state outputs. This device can be used for switching between various standards, such as 10 Base-T and 100 Base-T. Generally, this part can be used to replace mechanical relays in low voltage LAN applications that have physical layer, unshielded twisted pair media (UTP) with either CAT 3 or CAT 5 grade cable.

Logic Block Diagram



16-Pin Product Configuration



Product Pin Description

Pin Name	Description
IAn-IDn	Data Inputs
S	Select Inputs
E	Enable
YA-YD	Data Outputs
GND	Ground
Vcc	Power

Truth Table(1)

Ē	S	YA	YB	YC	YD	Function
Н	X	Hi-Z	Hi-Z	Hi-Z	Hi-Z	Disable
L	L	IA0	IB0	IC0	ID0	S = 0
L	Н	IA1	IB1	IC1	ID1	S = 1

Note:

1. H = High Voltage Level

L = Low Voltage Level

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Maximum Ratings

(Above which the useful life may be impaired. For user guidelines, not tested.)

Storage Temperature
Ambient Temperature with Power Applied
Supply Voltage to Ground Potential (Inputs & Vcc Only)0.5V to +4.6V
Supply Voltage to Ground Potential (Outputs & D/O Only)0.5V to +4.6V
DC Input Voltage0.5V to +4.6V
DC Output Current
Power Dissipation

Note:

Stresses greater than those listed under MAXIMUM RATINGS may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect reliability.

DC Electrical Characteristics (Over the Operating Range, $T_A = 0$ °C to +70°C, $V_{CC} = 3.3 \text{V} \pm 5\%$)

Parameters	Description	Test Conditions(1)	Min.	Typ ⁽²⁾	Max.	Units
V _{IH}	Input HIGH Voltage	Guaranteed Logic HIGH Level	2.0	_	_	v
V _{IL}	Input LOW Voltage	Guaranteed Logic LOW Level	-0.5	_	0.8	V
I_{IH}	Input HIGH Current	$V_{CC} = Max., V_{IN} = V_{CC}$		_	±1	
I_{IL}	Input LOW Current	$V_{CC} = Max., V_{IN} = GND$	_	_	±1	μΑ
I _{OZH}	High Impedance Output Current	$0 \le A, B \le V_{CC}$	_	_	±1	
V _{IK}	Clamp Diode Voltage	$V_{CC} = Min., I_{IN} = -18mA$		_	-1.2	V
I _{OS}	Short Circuit Current ⁽³⁾	$A (B) = 0V, B (A) = V_{CC}$	100	_	_	mA
V _H	Input Hysteresis at Control Pins			150	_	mV
D (6)	Cyvitale On Desistance	$V_{CC} = Min., V_{IN} = 0V, I_{ON} = 48mA$	_	5	7	
R _{ON} (6)	Switch On Resistance	$V_{CC} = Min., V_{IN} = 2.4V, I_{ON} = 15mA$	_	10	15	Ω
$\Delta R_{ m ON}$	On Resistance Match	$V_{IN} = 3.0V$, $E = LOW$	_	_	_	

Notes:

- 1. For Max. or Min. conditions, use appropriate value specified under Electrical Characteristics for applicable device type.
- 2. Typical values are at $V_{CC} = 3.3V$, $T_A = 25$ °C ambient temperature.
- 3. Not more than one output should be shorted at one time. Duration of the test should not exceed one second.
- 4. Von (min) value is at $V_{CC} = 3.3V$, $T_A = 70$ °C.

Capacitance ($T_A = 25^{\circ}C$, f = 1 MHz)

Parameters ⁽¹⁾	Description	Test Conditions	Тур	Max.	Units
C _{IN}	Input Capacitance	V _{IN} =0V		3	pF
C _{OFF}	Capacitance, Switch Off (Y)	$V_{IN} = 0V$		17	pF
C _{ON}	Capacitance, Switch On	$V_{IN} = 0V$		25	pF
C _{OFF}	Capacitance, Switch Off (A/B)	V _{IN} =0V		8	pF

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Note:

1. This parameter is determined by device characterization but is not production tested.



Power Supply Characteristics

Parameters	Description	Test Conditions ⁽¹⁾		Min.	Typ ⁽²⁾	Max.	Units
I_{CC}	Quiescent Power Supply Current	V _{CC} =Max.	V_{IN} =GND or V_{CC}	_	0.1	3.0	μА
ΔI_{CC}	Supply Current per Input @ TTL HIGH	V _{CC} =Max.	$V_{IN}=3.4V^{(3)}$	_	_	750	μА
I _{CCD}	Supply Current per Input per MHz ⁽⁴⁾	V _{CC} =Max., Input Pins Open E=GND Control Input Toggling 50% Duty Cycle		_	_	0.25	mA/ MHz

Notes:

- 1. For Max. or Min. conditions, use appropriate value specified under Electrical Characteristics for the applicable device.
- 2. Typical values are at $V_{CC} = 3.3V$, $+25^{\circ}C$ ambient.
- 3. Per TTL driven input ($V_{IN} = 3.0V$, control inputs only); A and B pins do not contribute to I_{CC} .
- 4. This current applies to the control inputs only and represent the current required to switch internal capacitance at the specified frequency. The A and B inputs generate no significant AC or DC currents as they transition. This parameter is not tested, but is guaranteed by design.

Switching Characteristics over Operating Range

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				Com.		
Parameters	Description	Conditions ⁽¹⁾	Min	Тур	Max	Unit
t _{PLH}	Propagation Delay ^(2,3) In to Y		_	_	0.25	ns
t _{SY}	Bus Enable Time S to Y	$C_L = 50 pF$ $R_L = 500 \Omega$	1	_	4.5	ns
t _{PHZ}	Bus Disable Time Ē to Y		1		4.5	ns
X _{TALK}	Crosstalk	$R_{L} = 100\Omega$ $f = 30 \text{ MHz}$ See Figure 2	_	-90	_	dB
O _{IRR}	Off Isolation	$R_L = 100\Omega$ $f = 30 \text{ MHz}$	_	-45	_	dB
B_{W}	-3dB Bandwidth	$R_L = 100\Omega$ See Figure 2	_	213	_	MHz
t _{ON}	Turn On Time	$R_L = 100\Omega$				ns
t _{OFF}	Turn Off Time	C _L = 35pF See Figure 1	_			ns

Notes:

- 1. See test circuit and waveforms.
- 2. This parameter is guaranteed but not tested.
- 3. The bus switch contributes no propagational delay other than the RC delay of the ON resistance of the switch and the load capacitance. The time constant for the switch alone is of the order of 0.25ns for 50pF load. Since this time constant is much smaller than the rise/fall times of typical driving signals, it adds very little propagational delay to the system. Propagational delay of the bus switch when used in a system is determined by the driving circuit on the driving side of the switch and its interaction with the load on the driven side.

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Applications

LAN Switch

The PI3L100 was designed to switch between various standards such as 10Base-T, 100Base-T, 100VG-AnyLAN, and Token Ring. Also general purpose applications such as loopback, line termination, and line clamps that might normally use mechanical relays are also ideal uses for this LAN Switch (see Figure 1). Generally speaking, this LAN Switch can be used for data rates to 200 Mbps and data signal levels from 0V to 3.6V.

LAN Standards	Data Rate per twisted pair (UTP)
10Base-T	10 Mbps
100Base-T	100 Mbps
100VG-AnyLAN	25 Mbps

V_{CC} Bias Voltage vs. Ron

To keep R_{ON} to a minimum, it is recommended that the V_{CC} voltage be increased to a voltage between 3.3V and 3.6V. Ideally an input voltage between 0.2V and 3.6V will keep R_{ON} flat.

Signal Distortion

Distortion of the input signal is equated to 20LOG $\Delta R_{ON}/R_L$. So keeping R_{ON} flat as the data signal level varies is critical to low distortion. It should also be noted that increasing the data rate increases harmonic distortion which also effects the signal amplitude.

Test Circuits

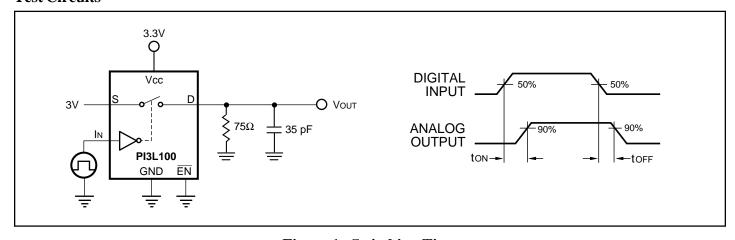


Figure 1. Switching Time

Ordering Information

Part	Pin Package	Temperature
PI3L100Q	16 QSOP (Q)	−40°C to +85°C
PI3L100L	16 TSSOP (L)	−40°C to +85°C

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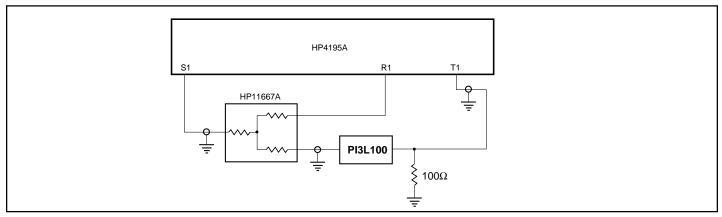


Figure 2. Gain/Phase Crosstalk, Off Isolation

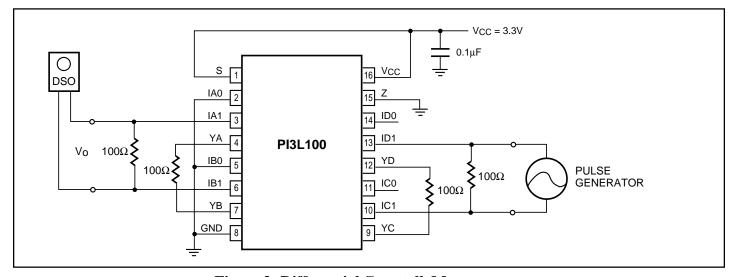


Figure 3. Differential Crosstalk Measurement

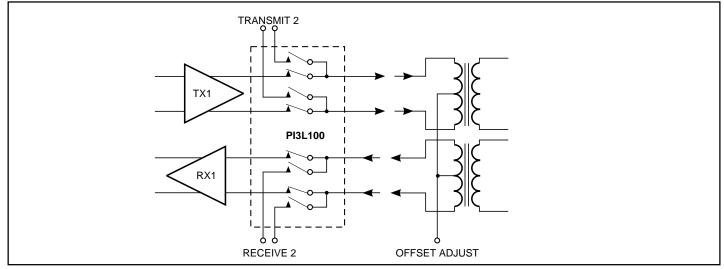


Figure 4a. Full Duplex Transceiver

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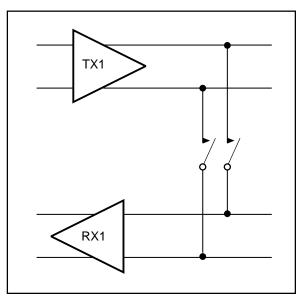


Figure 4b. Loop Back

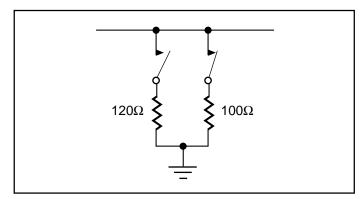


Figure 4c. Line Termination

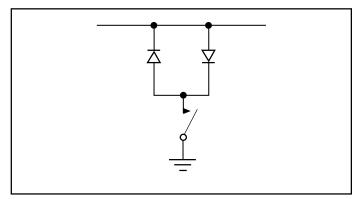


Figure 4d. Line Clamp

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